

Semicon Singapore 2007

While Semicon Singapore, held from 8 – 10 May, is a relatively smaller in scale catering to the South-east Asian semiconductor industry, it still attracted 8,283 visitors and 338 exhibiting companies.

There were several demo equipment displayed in ZMC's booth. **Visdynamics** showcased their latest T8 - Tray Scanning with Tape and Reel System with the innovative Universal Gang Pick (UGP). **MJC** also displayed their latest U-Probe, together with the V-Probe and Package Probe. Also featured were **Reid-Ashman's** Manipulator, **ISIS'** Contactless Wafer Thickness Measurement system, and **IDC's** Wafer transportation/handling equipment.

Other co-exhibitors included **MJC Probe Inc**, **Thermal Product Solutions**, and **Soft Test Asia**.

